KM-23YD-F

YELLOW

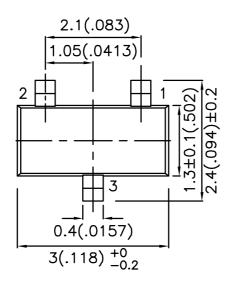
Features

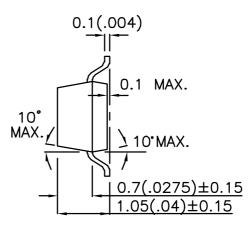
- •SOT-23 PACKAGE SURFACE MOUNT LED LAMP.
- •LOW POWER CONSUMPTION.
- •LONG LIFE SOLID STATE RELIABILITY.
- ●PACKAGE: 2000PCS / REEL.
- ●RoHS COMPLIANT.

Description

The Yellow source color devices are made with Gallium Arsenide Phosphide on Gallium Phosphide Yellow Light Emitting Diode.

Package Dimensions





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- 1 ANODE
- 2 N.C.
- 3 CATHODE

Notes

- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is $\pm 0.25 (0.01\mbox{"})$ unless otherwise noted.
- 3. Lead spacing is measured where the lead emerge from the package.
- 4. Specifications are subject to change without notice.

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Selection Guide

Part No.	Dice	Lens Type	lv (mcd) @ 20mA		Viewing Angle
		,	Min.	Тур.	2 θ 1/2
KM-23YD-F	YELLOW (GaAsP/GaP)	YELLOW DIFFUSED	1.6	5	140°

Electrical / Optical Characteristics at Ta=25°C

Symbol	Parameter	Device	Тур.	Max.	Units	Test Conditions
λpeak	Peak Wavelength	Yellow	590		nm	IF=20mA
λD	Dominant Wavelength	Yellow	588		nm	IF=20mA
Δλ1/2	Spectral Line Half-width	Yellow	35		nm	IF=20mA
С	Capacitance	Yellow	20		pF	VF=0V;f=1MHz
VF	Forward Voltage	Yellow	2.1	2.5	V	IF=20mA
IR	Reverse Current	Yellow		10	uA	VR = 5V

Absolute Maximum Ratings at T_A=25°C

Parameter	Yellow	Units	
Power dissipation	105	mW	
DC Forward Current	30	mA	
Peak Forward Current [1]	140	mA	
Reverse Voltage	5	V	
Operating/Storage Temperature	-40°C To +85°C		

Note:

1. 1/10 Duty Cycle, 0.1ms Pulse Width.

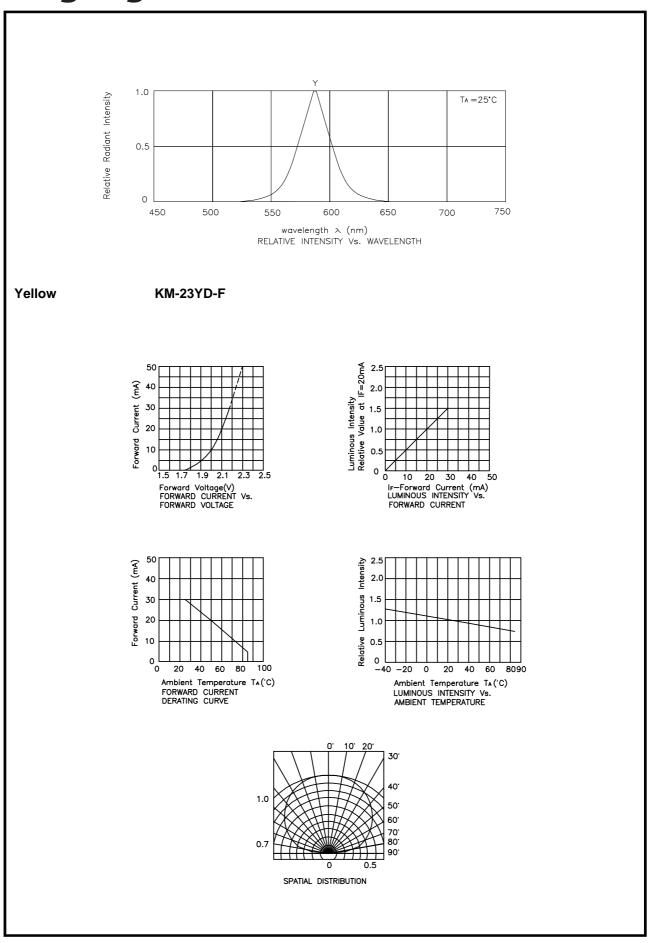
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CHECKED: Allen Liu

Note: 1. θ 1/2 is the angle from optical centerline where the luminous intensity is 1/2 the optical centerline value.

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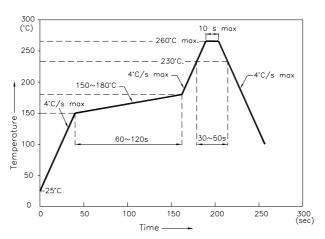
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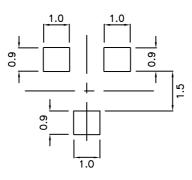
Reflow Soldering Profile For Lead-free SMT Process.



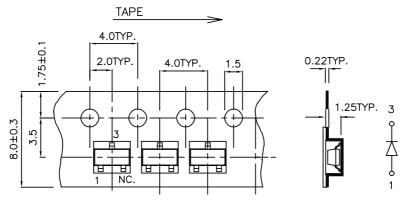
NOTES:

- 1.We recommend the reflow temperature 245°C(+/-5°C).The maximum soldering temperature should be limited to 260°C.
- 2.Don't cause stress to the epoxy resin while it $\,$ is exposed to high temperature.
- 3. Number of reflow process shall be 2 times or less.

Recommended Soldering Pattern (Units: mm)



Tape Specifications (Units: mm)



Remarks:

If special sorting is required (e.g. binning based on forward voltage, luminous intensity, or wavelength), the typical accuracy of the sorting process is as follows:

- 1. Wavelength: +/-1nm
- 2. Luminous Intensity: +/-15%
- 3. Forward Voltage: +/-0.1V

Note: Accuracy may depend on the sorting parameters.

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